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(12) **United States Design Patent**  
**Yang et al.**

(10) **Patent No.:** **US D1,007,299 S**

(45) **Date of Patent:** **\*\* \*Dec. 12, 2023**

(54) **PACKAGE**

ebay.com/itm/313762185341?chn=ps&mkevt=1&mkcid=28> (Year: 2021).\*

(71) Applicant: **SPIGEN KOREA CO., LTD.**, Seoul (KR)

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(57) **CLAIM**

(73) Assignee: **SPIGEN KOREA CO., LTD.**, Seoul (KR)

The ornamental design for a package, as shown and described.

(\* ) Notice: This patent is subject to a terminal disclaimer.

**DESCRIPTION**

(\*\*) Term: **15 Years**

FIG. 1 is a front perspective view of a package showing our new design according to a first embodiment of our design; FIG. 2 is a front elevational view thereof; FIG. 3 is a rear elevational view thereof; FIG. 4 is a left side elevational view thereof; FIG. 5 is a right side elevational view thereof; FIG. 6 is a top plan view thereof; FIG. 7 is a bottom plan view thereof; FIG. 8 is a front perspective view of the package according to a second embodiment of our design; FIG. 9 is a front elevational view thereof; FIG. 10 is a rear elevational view thereof; FIG. 11 is a left side elevational view thereof; FIG. 12 is a right side elevational view thereof; FIG. 13 is a top plan view thereof; FIG. 14 is a bottom plan view thereof; FIG. 15 is a front perspective view of the package according to a third embodiment of our design; FIG. 16 is a front elevational view thereof; FIG. 17 is a rear elevational view thereof; FIG. 18 is a left side elevational view thereof; FIG. 19 is a right side elevational view thereof; FIG. 20 is a top plan view thereof; FIG. 21 is a bottom plan view thereof; and, FIG. 22 is a front elevational view of the package according to a fourth embodiment of our design.

(21) Appl. No.: **29/652,369**

(22) Filed: **Jul. 28, 2020**

(51) **LOC (14) Cl.** ..... **09-03**

(52) **U.S. Cl.**  
USPC ..... **D9/432**

(58) **Field of Classification Search**  
USPC ..... D9/413-435, 721, 737, 711, 456, 457, D9/499

(Continued)

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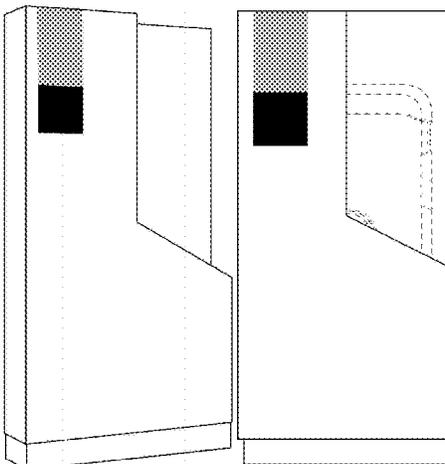
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According to the fourth embodiment of our design, the only difference from the first embodiment is that it contains an illustrative image of a product on the front surface of the  
(Continued)



package, it being understood that all other surfaces are the same as those of the first embodiment.

The broken lines throughout the drawing figures depict portions of the package that form no part of the claimed design. The broken lines and regions bounded by broken lines form no part of the claimed design.

**1 Claim, 22 Drawing Sheets**

(58) **Field of Classification Search**

CPC . B65D 1/00; B65D 23/00; B65D 5/00; B65D 5/0095

See application file for complete search history.

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FIG. 1

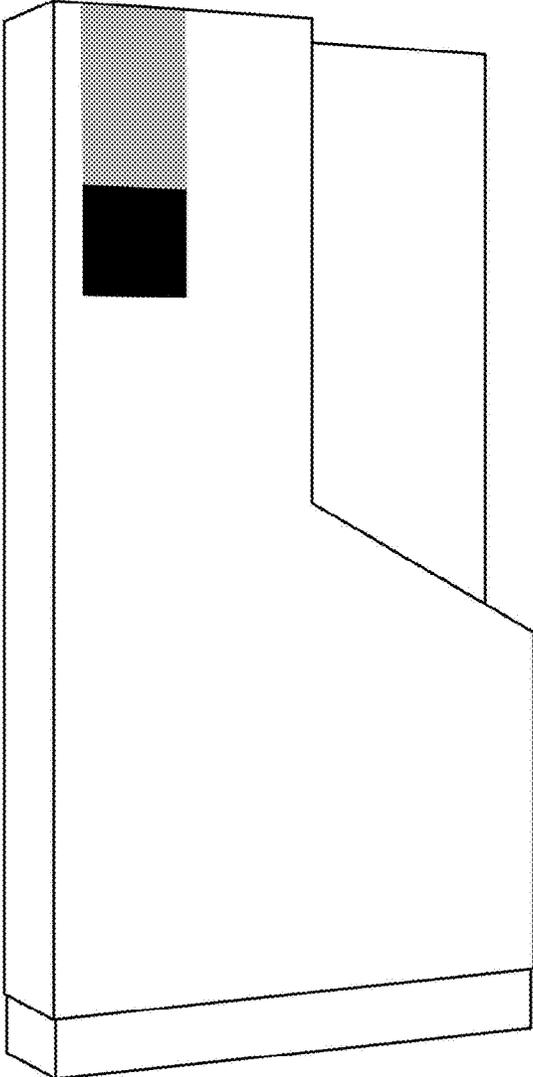


FIG. 2

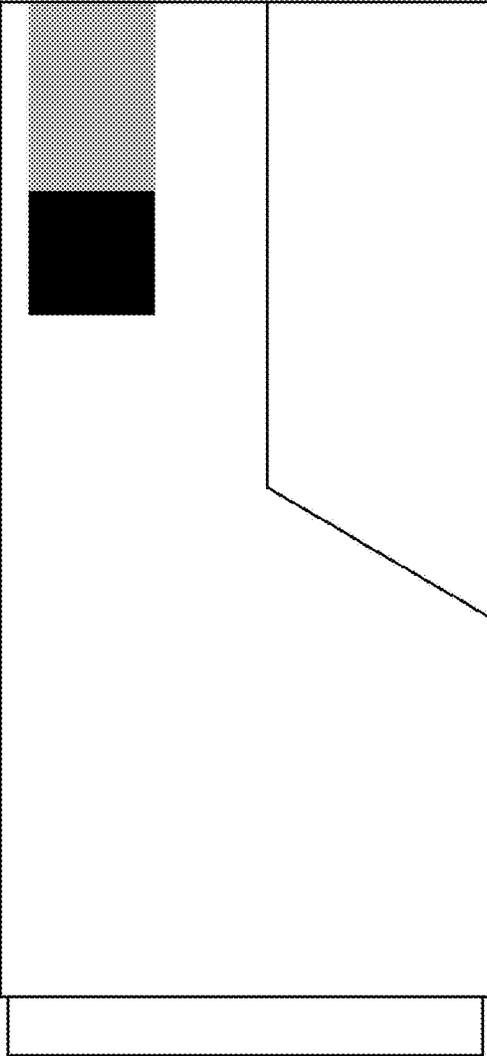


FIG. 3

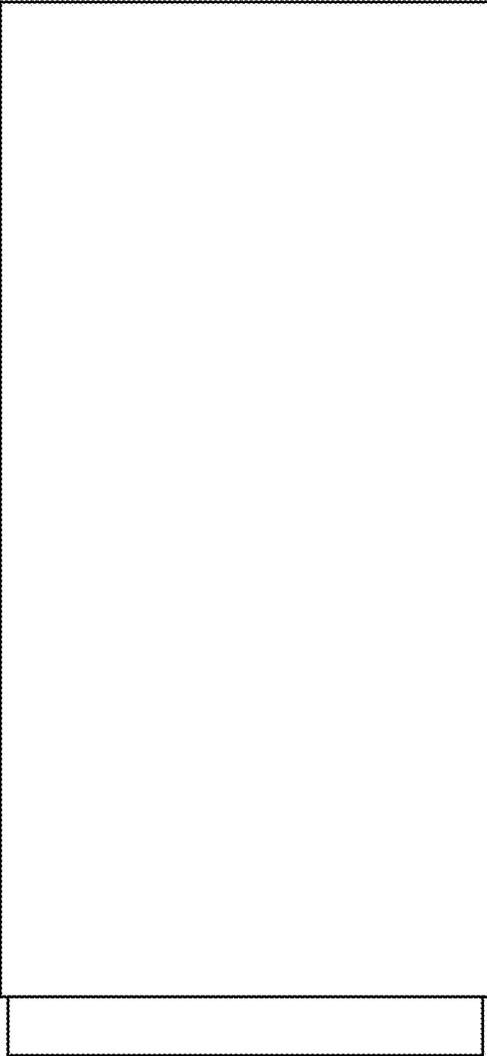


FIG. 4



FIG. 5



FIG. 6

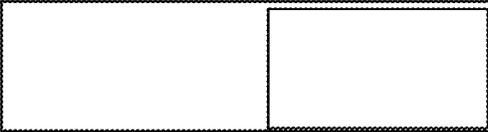


FIG. 7



FIG. 8

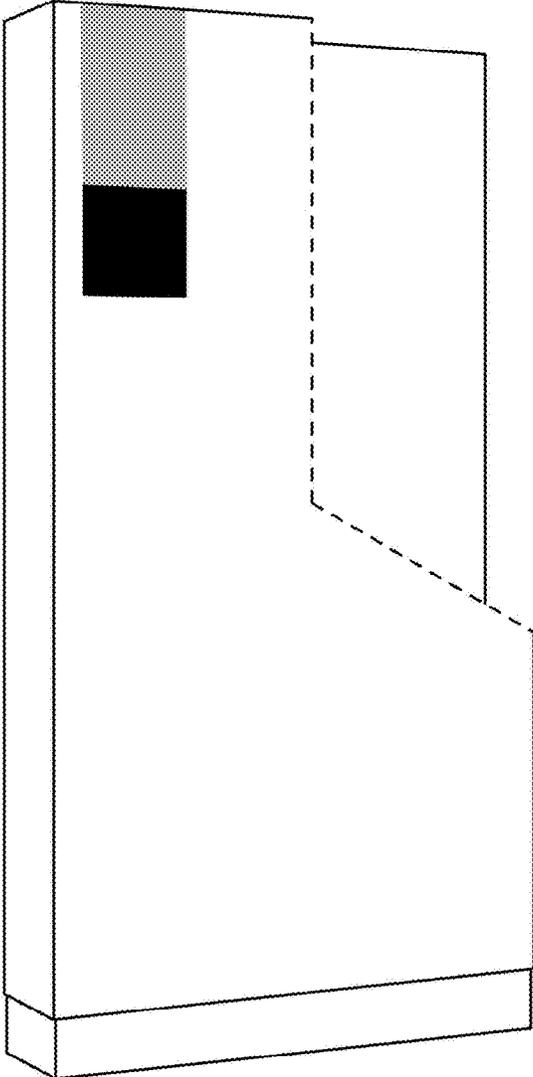


FIG. 9

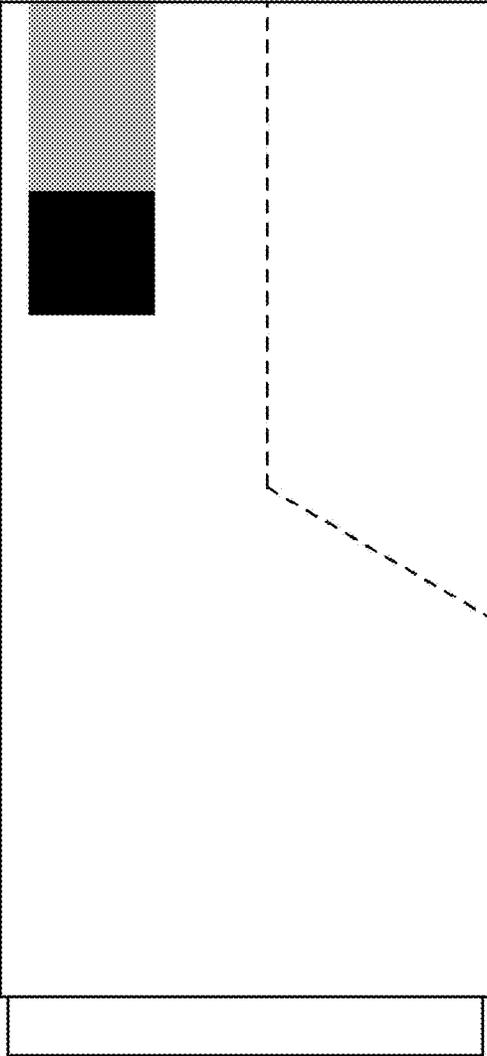


FIG. 10



FIG. 11



FIG. 12

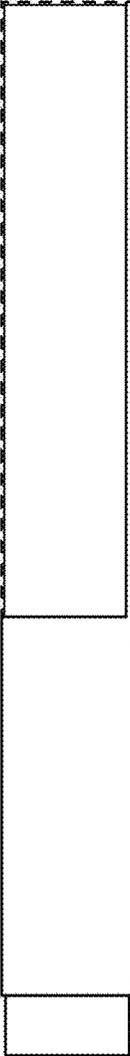


FIG. 13



FIG. 14



FIG. 15

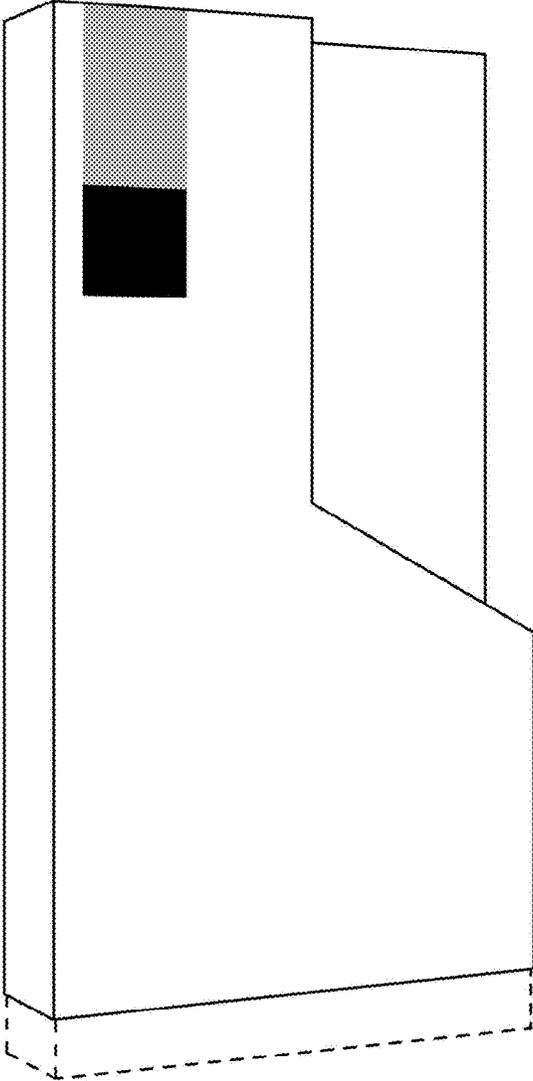


FIG. 16

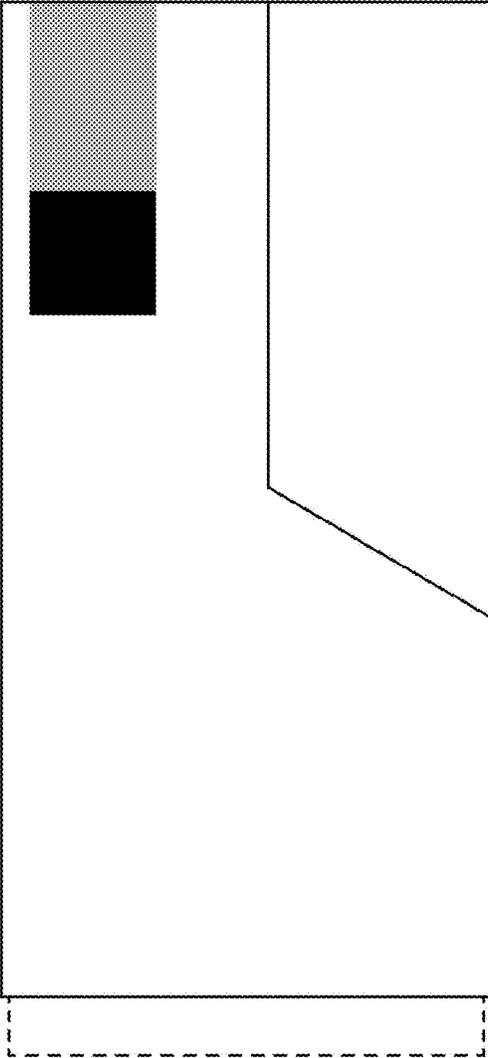


FIG. 17



FIG. 18

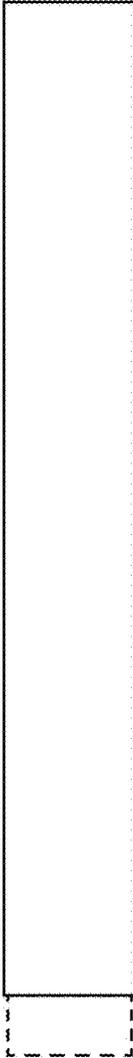


FIG. 19

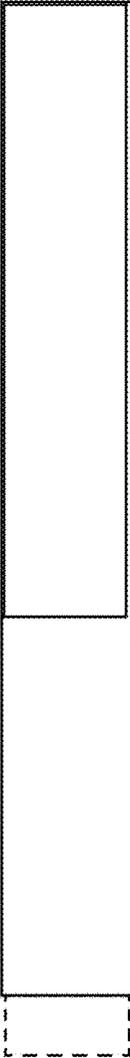


FIG. 20

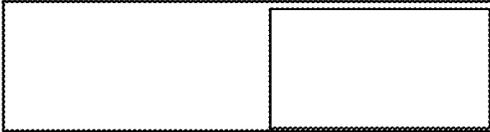


FIG. 21



FIG. 22

